



**GaAs MMIC I/Q DOWNCONVERTER
24 - 28 GHz**

Data Taken As IRM With External IF Hybrid

Conversion Gain vs. Temperature

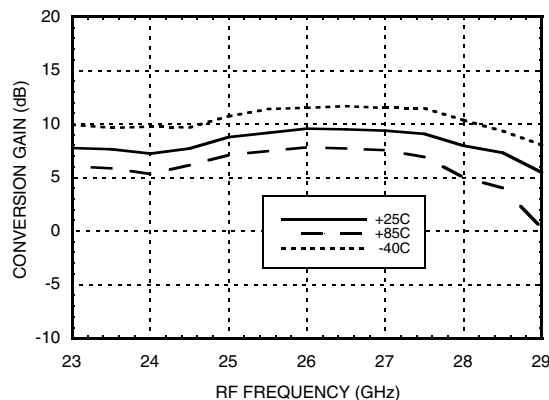
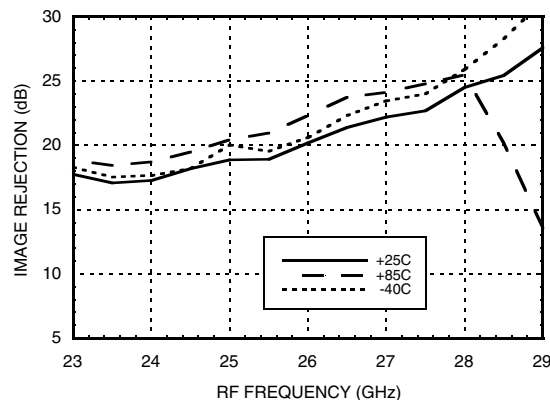
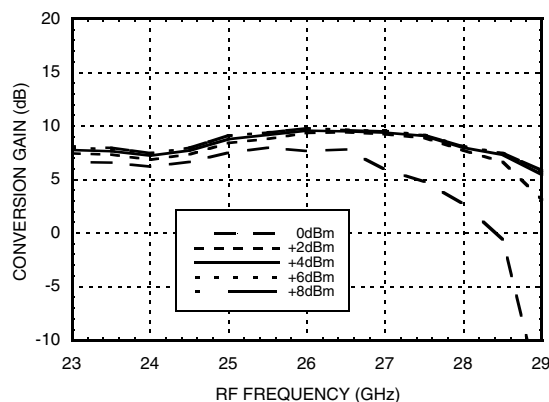


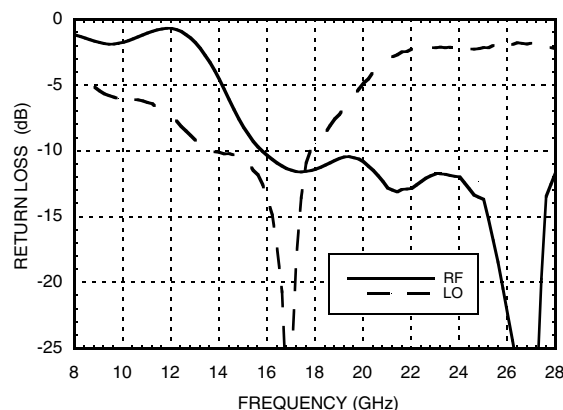
Image Rejection vs. Temperature



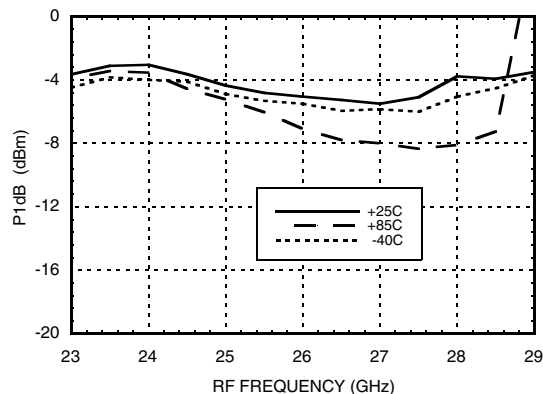
Conversion Gain vs. LO Drive



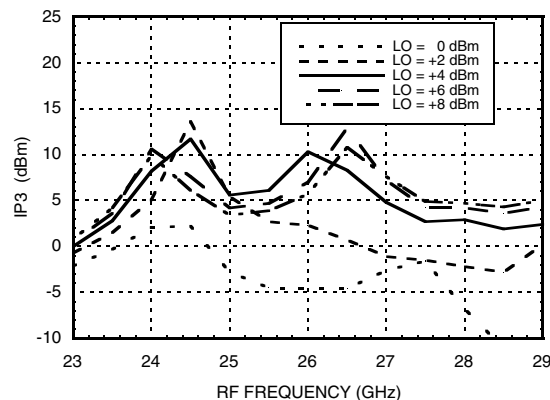
Return Loss

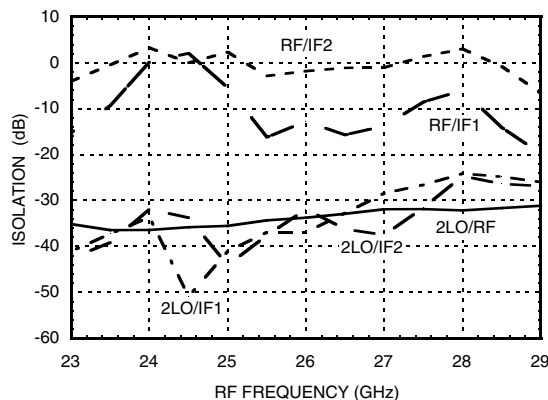
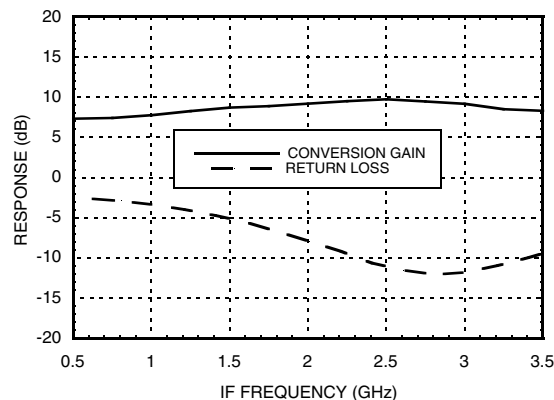
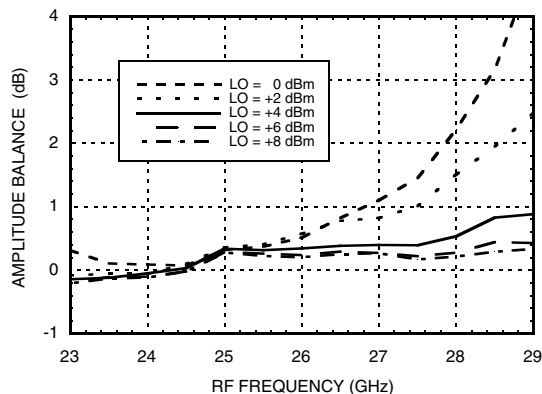
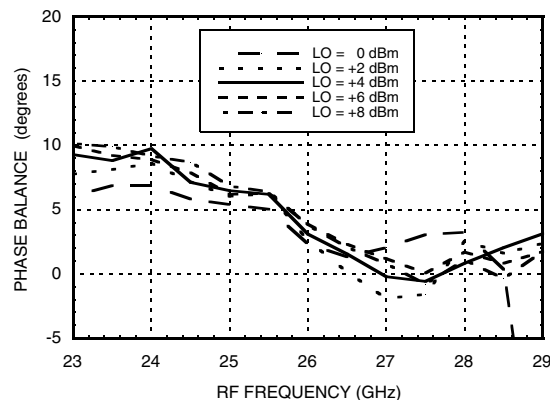
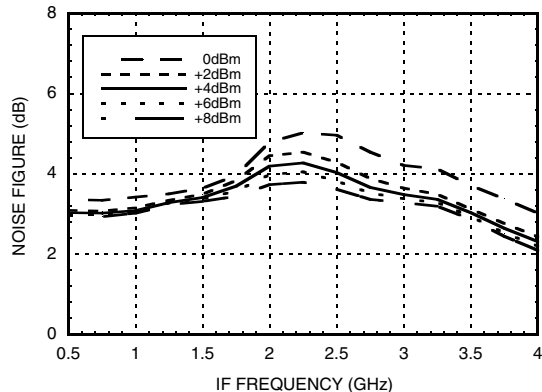
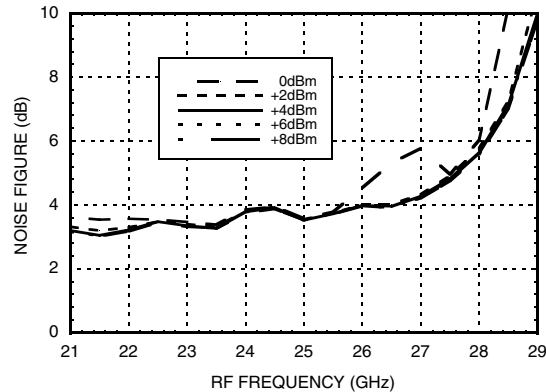


Input P1dB vs. Temperature



Input IP3 vs. LO Drive




**GaAs MMIC I/Q DOWNCONVERTER
24 - 28 GHz**
Quadrature Channel Data Taken Without IF Hybrid
Isolations

IF Bandwidth*

Amplitude Balance vs. LO Drive

Phase Balance vs. LO Drive

**Noise Figure vs. LO Drive,
LO Frequency = 12 GHz**

**Noise Figure vs. LO Drive,
IF Frequency = 100 MHz**


* Conversion gain data taken with external IF hybrid, LO frequency fixed at 12 GHz and RF varied

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GaAs MMIC I/Q DOWNCONVERTER
24 - 28 GHz
MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	37	12	32	45
1	12	41	0	37	41
2	xx	xx	66	70	46
3	xx	xx	xx	xx	79
4	xx	xx	xx	xx	xx

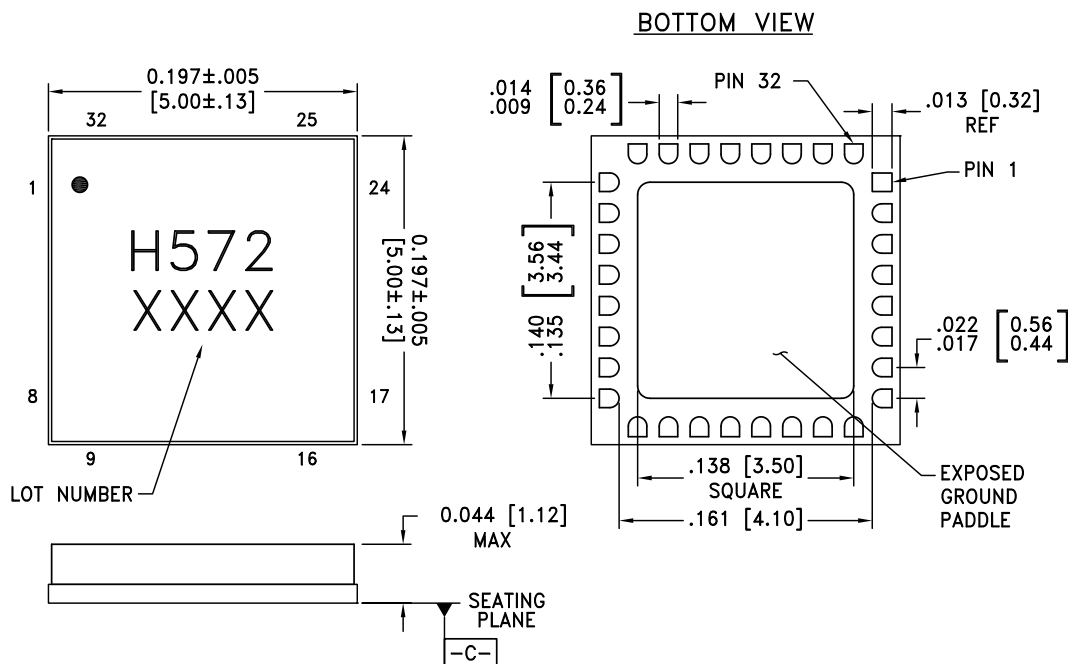
RF = 25 GHz @ -20 dBm
LO = 12 GHz @ +4 dBm
Data taken without IF hybrid
All values in dBc below IF power level (1RF -2LO = 1 GHz)

Absolute Maximum Ratings

RF	+2 dBm
LO Drive	+ 13 dBm
Vdd	5.5V
Channel Temperature	175°C
Continuous P _{diss} (T=85°C) (derate 9.56 mW/°C above 85°C)	860 mW
Thermal Resistance (R _{TH}) (channel to package bottom)	104.6 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C
ESD Sensitivity (HBM)	Class 1B



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS


GaAs MMIC I/Q DOWNCONVERTER
24 - 28 GHz
Outline Drawing

NOTES:

1. PACKAGE BODY MATERIAL: ALUMINA
2. LEAD AND GROUND PADDLE PLATING: 30 - 80 MICROINCHES GOLD OVER 50 MICROINCHES MINIMUM NICKLE
3. DIMENSIONS ARE IN INCHES [MILLIMETERS]
4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM
6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[2]
HMC572LC5	Alumina, White	Gold over Nickel	MSL3 ^[1]	H572 XXXX

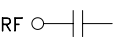
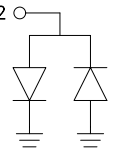
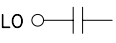
[1] Max peak reflow temperature of 260 °C

[2] 4-Digit lot number XXXX

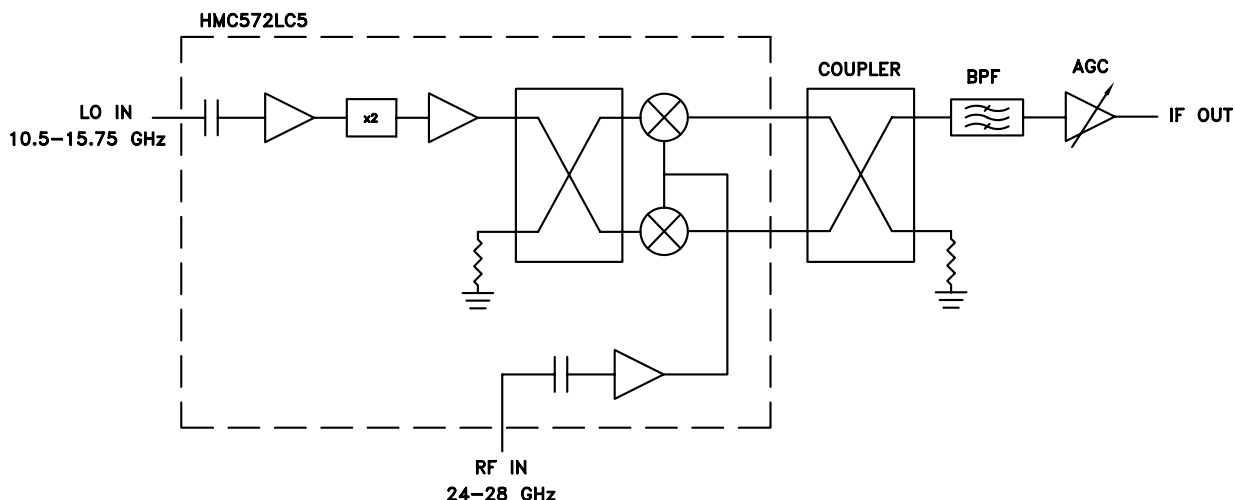


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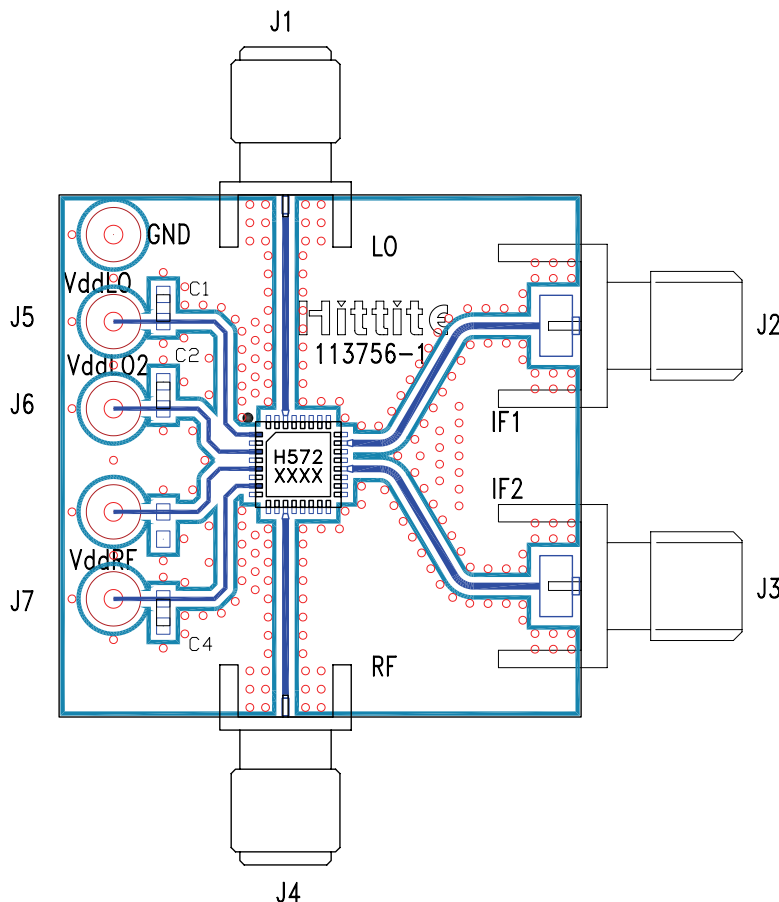
Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	VddLO	Power supply for first stage of LO amplifier.	VddLO 
2, 4 - 6, 8, 9, 12 - 18, 21, 22, 25 - 28, 31, 32	N/C	No connection required. These pins may be connected to RF/DC ground without affecting performance.	
3	VddLO2	Power supply for second stage of LO amplifier.	VddLO2 
7	VddRF	Power supply for RF LNA.	VddRF 
10, 19, 24, 29	GND	These pins and ground paddle must be connected to RF/DC ground.	
11	RF	This pin is AC coupled and matched to 50 Ohms.	RF 
20	IF2	This pin is DC coupled for applications not requiring operation to DC. This port should be DC blocked externally using a series capacitor whose value has been chosen to pass the necessary frequency range. For operation to DC, this pin must not sink / source more than 3 mA of current or part non-function and possible failure will result.	IF1, IF2 
23	IF1		
30	LO	This pin is AC coupled and matched to 50 Ohms.	LO 

Typical Application



Evaluation PCB



List of Materials for Evaluation PCB 113758 ^[1]

Item	Description
C1 - C4	Capacitor 0603, 0.01 μ F
J1, J4	PCB Mount SMA RF Connector, SRI
J2, J3	PCB Mount SMA Connector, Johnson
J5 - J7	DC Pin
U1	HMC572LC5
PCB ^[2]	113756 Evaluation Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

